



Geckos inspire new method to print electronics on complex surfaces

Wednesday, September 22, 2010



Geckos are masters at sticking to surfaces of all kinds and easily unsticking themselves, too. Inspired by these lizards, a team of engineers has developed a reversible adhesion method for printing electronics on a variety of tricky surfaces such as clothes, plastic, and leather.

Researchers from Northwestern University and the University of Illinois at Urbana-Champaign designed a clever square polymer stamp that allows them to vary its adhesion strength. The stamp can easily pick up an array of electronic devices from a silicon surface and move and print them on a curved surface.

The research was published by the *Proceedings of the National Academy of Sciences (PNAS)*.

"Our work proposes a very robust method to transfer and print electronics on complex surfaces," said Yonggang Huang, Joseph Cummings Professor of Civil and Environmental Engineering and Mechanical Engineering at Northwestern's McCormick School of Engineering and Applied Science.

Huang, co-corresponding author of the *PNAS* paper, led the theory and design work at Northwestern. His colleague John Rogers, the Flory-Founder Chair Professor of Materials Science and Engineering at the University of Illinois, led the experimental and fabrication work. Rogers is a co-corresponding author of the paper.

Key to the square and squeezable polymer stamp are four pyramid-shaped tips on the stamp's bottom, one in each corner. They mimic, in a way, the micro- and nano-filaments on the gecko's foot, which the animal uses to control adhesion by increasing or decreasing contact area with a surface.

Pressing the stamp against the electronics causes the soft tips to collapse up against the stamp's body, maximizing the contact area between the stamp and the electronics and creating adhesion. The electronics are picked up in a complete batch, and, with the force removed, the soft tips snap back to their original shape. The electronics now are held in place by just the four tips, a small contact area. This allows the electronics to be easily transferred to a new surface.

"Design of the pyramid tips is very important," Huang said. "The tips have to be the right height. If the tips are too large, they can't pick up the target, and if the tips are too small, they won't bounce back to their shape."

The researchers conducted tests of the stamp and found the changes in contact area allow the stamp's adhesion strength to vary by 1,000 times. They also demonstrated their method can print layers of electronics, enabling the development of a variety of complex devices.

The National Science Foundation and the U.S. Department of Energy supported the work.

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